

RoHS

COMPLIANT

HALOGEN

Vishay Siliconix

N-Channel 40-V (D-S) MOSFET

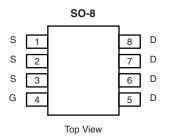
PRODUCT SUMMARY						
V _{DS} (V)	R _{DS(on)} (Ω)	I _D (A) ^a	Q _g (Typ.)			
40	0.0038 at V _{GS} = 10 V	33	37.5 nC			
	0.0045 at V _{GS} = 4.5 V	31	37.5110			

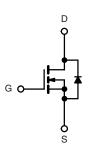
FEATURES

- Halogen-free According to IEC 61249-2-21
 Available
- TrenchFET[®] Gen II Power MOSFET
- 100 % R_a and UIS Tested

APPLICATIONS

- Secondary Rectification
- · Point of Load





Ordering Information: Si4456DY-T1-E3 (Lead (Pb)-free) Si4456DY-T1-GE3 (Lead (Pb)-free and Halogen-free)

N-Channel MOSFET

Parameter	Symbol	Limit	Unit		
Drain-Source Voltage		V _{DS}	40		
Gate-Source Voltage		V _{GS}	± 20	V	
	T _C = 25 °C		33		
Continuous Drain Current (T _{.1} = 150 °C)	T _C = 70 °C	1-	27		
Continuous Drain Current (1) = 150°C)	T _A = 25 °C	I _D	23 ^{b, c}		
	T _A = 70 °C		18 ^{b, c}	•	
Pulsed Drain Current		I _{DM}	70	— A	
	T _C = 25 °C		7.0		
Continuous Source-Drain Diode Current	T _A = 25 °C	۱ _S	3.0 ^{b, c}		
Avalanche Current		I _{AS}	40		
Single Pulse Avalanche Energy	L = 0.1 mH	E _{AS}	80	mJ	
	T _C = 25 °C		7.8		
Movimum Dower Dissinction	T _C = 70 °C	P	5.0	w	
Maximum Power Dissipation	T _A = 25 °C	P _D	3.5 ^{b, c}	vv	
	T _A = 70 °C		2.2 ^{b, c}	\neg	
Operating Junction and Storage Temperature	T _J , T _{stg}	- 55 to 150	1		

THERMAL RESISTANCE RATINGS							
Parameter		Symbol	Typical	Maximum	Unit		
Maximum Junction-to-Ambient ^{b, d}	t ≤ 5 s	R _{thJA}	29	35	°C/W		
Maximum Junction-to-Foot (Drain)	Steady State	R _{thJF}	13	16	C/W		

Notes:

b. Surface Mounted on 1" x 1" FR4 board.

c. t = 5 s.

d. Maximum under steady state conditions is 80 °C/W.

a. Based on T_C = 25 °C.

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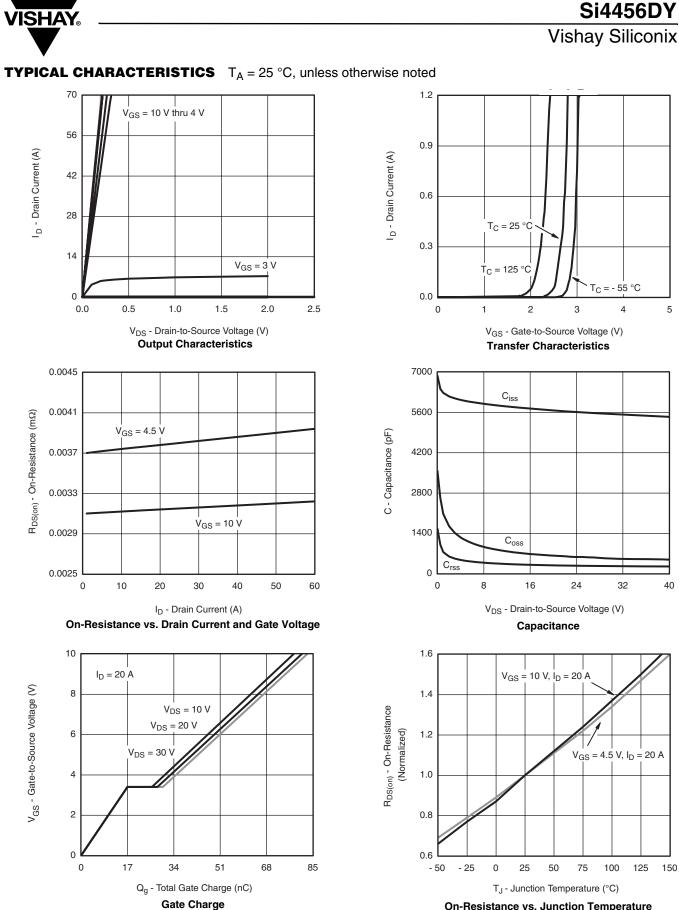
Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit
Static					1	1
Drain-Source Breakdown Voltage	V _{DS}	$V_{GS} = 0 V, I_{D} = 250 \mu A$	40			V
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	l _D = 250 μA		54		
V _{GS(th)} Temperature Coefficient	$\Delta V_{GS(th)}/T_J$	I _D = 250 μA		- 7		mV/°C
Gate-Source Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_{D} = 250 \ \mu A$	1.5		2.8	V
Gate-Source Leakage	I _{GSS}	$V_{DS} = 0 V, V_{GS} = \pm 20 V$			± 100	nA
Zaus Cata Visita as Dusis Convert	I _{DSS}	V _{DS} = 40 V, V _{GS} = 0 V			1	
Zero Gate Voltage Drain Current		$V_{DS} = 40 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 55 ^{\circ}\text{C}$			10	μΑ
On-State Drain Current ^a	I _{D(on)}	$V_{DS} = \ge 5 V, V_{GS} = 10 V$	30			Α
	P	$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 20 \text{ A}$		0.0031 0.0038		0
Drain-Source On-State Resistance ^a	R _{DS(on)}	V _{GS} = 4.5 V, I _D = 15 A		0.0037	0.0045	Ω
Forward Transconductance ^a	9 _{fs}	V _{DS} = 15 V, I _D = 20 A		110		S
Dynamic ^b	•					
Input Capacitance	C _{iss}			5670		pF
Output Capacitance	C _{oss}	V _{DS} = 20 V, V _{GS} = 0 V, f = 1 MHz		621		
Reverse Transfer Capacitance	C _{rss}			287		
Total Gate Charge	Qg	$V_{DS} = 20 \text{ V}, V_{GS} = 10 \text{ V}, I_{D} = 20 \text{ A}$		81	122	nC
				37.5	57	
Gate-Source Charge	Q _{gs}	$V_{DS} = 20 \text{ V}, V_{GS} = 4.5 \text{ V}, I_{D} = 20 \text{ A}$		17		
Gate-Drain Charge	Q _{gd}			11		
Gate Resistance	R _g	f = 1 MHz		1.05	1.6	Ω
Turn-On Delay Time	t _{d(on)}			145	220	
Rise Time	t _r	V_{DD} = 20 V, R_L = 2 Ω		208	320	1
Turn-Off DelayTime	t _{d(off)}	$I_D \cong$ 10 A, V_{GEN} = 4.5 V, R_g = 1 Ω		56	85	
Fall Time	t _f			15	23	
Turn-On Delay Time	t _{d(on)}			21	32	ns
Rise Time	t _r	V_{DD} = 20 V, R_L = 2 Ω		58	90	-
Turn-Off DelayTime	t _{d(off)}	$I_D \cong$ 10 A, V_{GEN} = 10 V, R_g = 1 Ω		55	85	
Fall Time	t _f			8	15	1
Drain-Source Body Diode Characterist	ics	•		•	•	•
Continous Source-Drain Diode Current	۱ _S	T _C = 25 °C			7	٨
Pulse Diode Forward Current ^a	I _{SM}				70	A
Body Diode Voltage	V _{SD}	I _S = 3 A		0.71	1.1	V
Body Diode Reverse Recovery Time	t _{rr}			38	60	ns
Body Diode Reverse Recovery Charge	Q _{rr}	L = 12.0 dt/dt = 100.0/up T = 05.00		42	65	nC
Reverse Recovery Fall Time	t _a	$I_{F} = 13 \text{ A}, \text{ dI/dt} = 100 \text{ A/}\mu\text{s}, T_{J} = 25 \text{ °C}$		21		ns
Reverse Recovery Rise Time t _b		1		17	1	1

Notes:

a. Pulse test; pulse width \leq 300 $\mu s,$ duty cycle \leq 2 %.

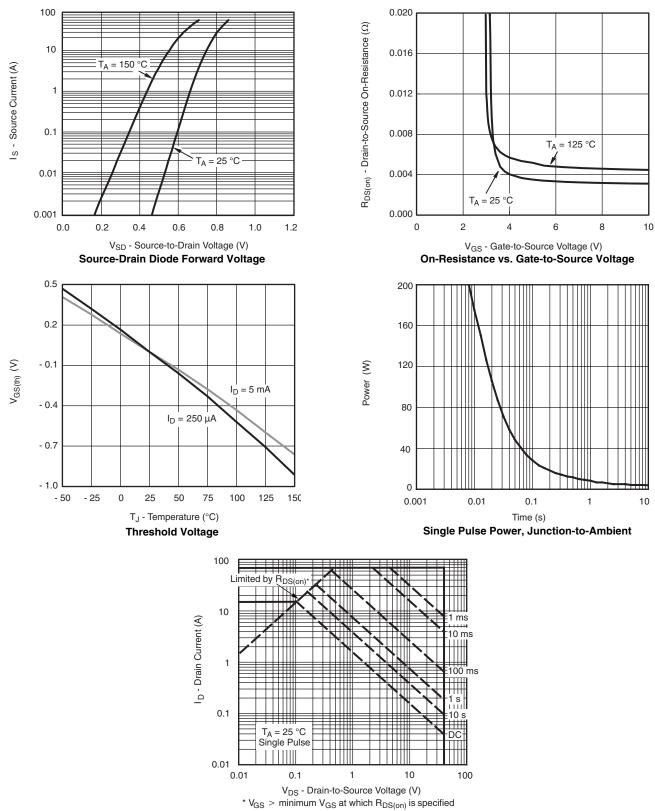
b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



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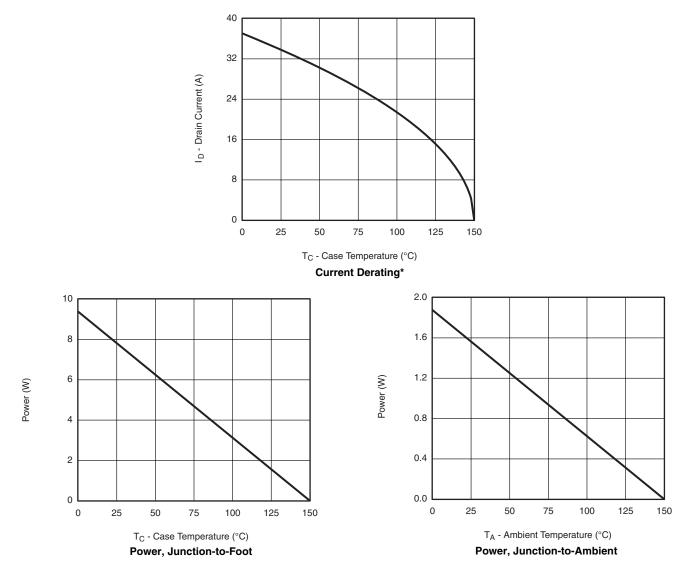
TYPICAL CHARACTERISTICS $T_A = 25 \text{ °C}$, unless otherwise noted



Safe Operating Area, Junction-to-Ambient



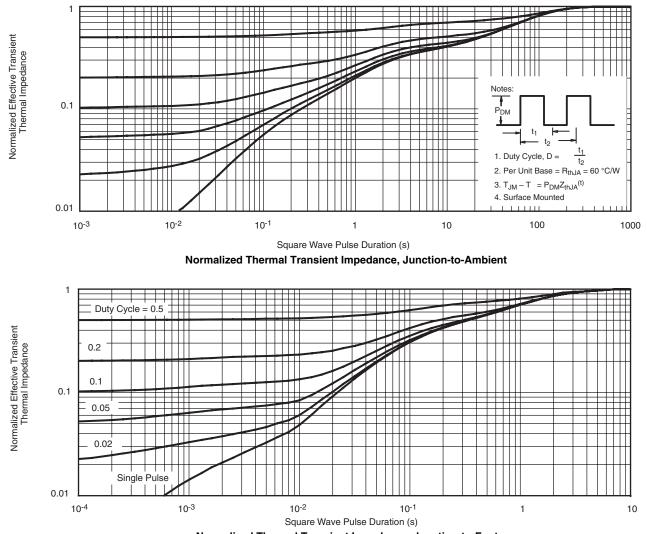
TYPICAL CHARACTERISTICS $T_A = 25 \text{ °C}$, unless otherwise noted



* The power dissipation P_D is based on $T_{J(max)}$ = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.

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TYPICAL CHARACTERISTICS $T_A = 25 \text{ °C}$, unless otherwise noted



Normalized Thermal Transient Impedance, Junction-to-Foot

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see www.vishay.com/ppg?73852.



Package Information

Vishay Siliconix

SOIC (NARROW): 8-LEAD JEDEC Part Number: MS-012





	MILLIM	IETERS	INCHES		
DIM	Min	Мах	Min	Max	
A	1.35	1.75	0.053	0.069	
A ₁	0.10	0.20	0.004	0.008	
В	0.35	0.51	0.014	0.020	
С	0.19	0.25	0.0075	0.010	
D	4.80	5.00	0.189	0.196	
E	3.80	4.00	0.150	0.157	
е	1.27	BSC	0.050 BSC		
н	5.80	6.20	0.228	0.244	
h	0.25	0.50	0.010	0.020	
L	0.50	0.93	0.020	0.037	
q	0°	8°	0°	8°	
S	0.44	0.64	0.018	0.026	
ECN: C-06527-Rev. I, 11-Sep-06 DWG: 5498					

Application Note 826

Vishay Siliconix



RECOMMENDED MINIMUM PADS FOR SO-8



Recommended Minimum Pads Dimensions in Inches/(mm)

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